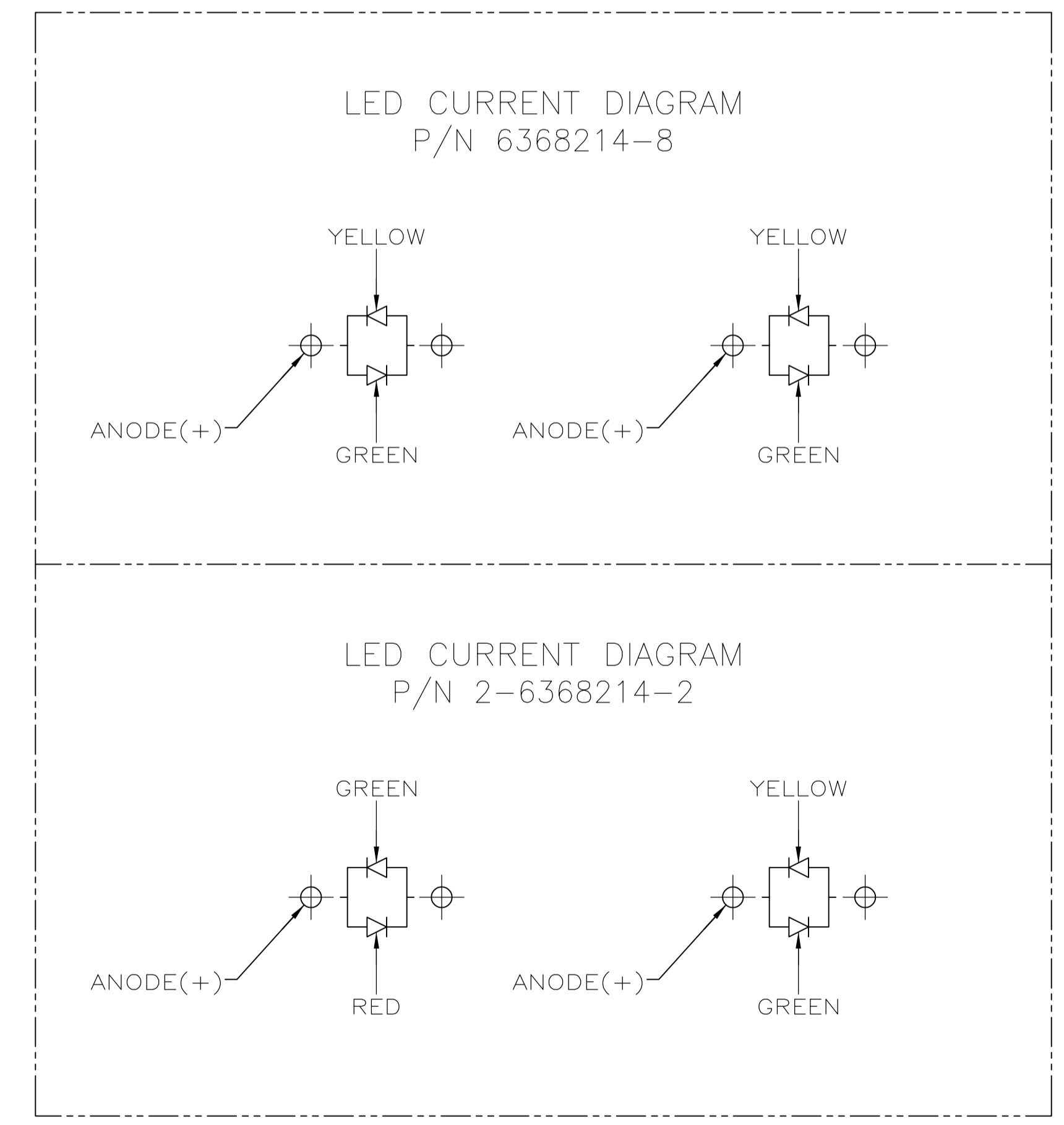
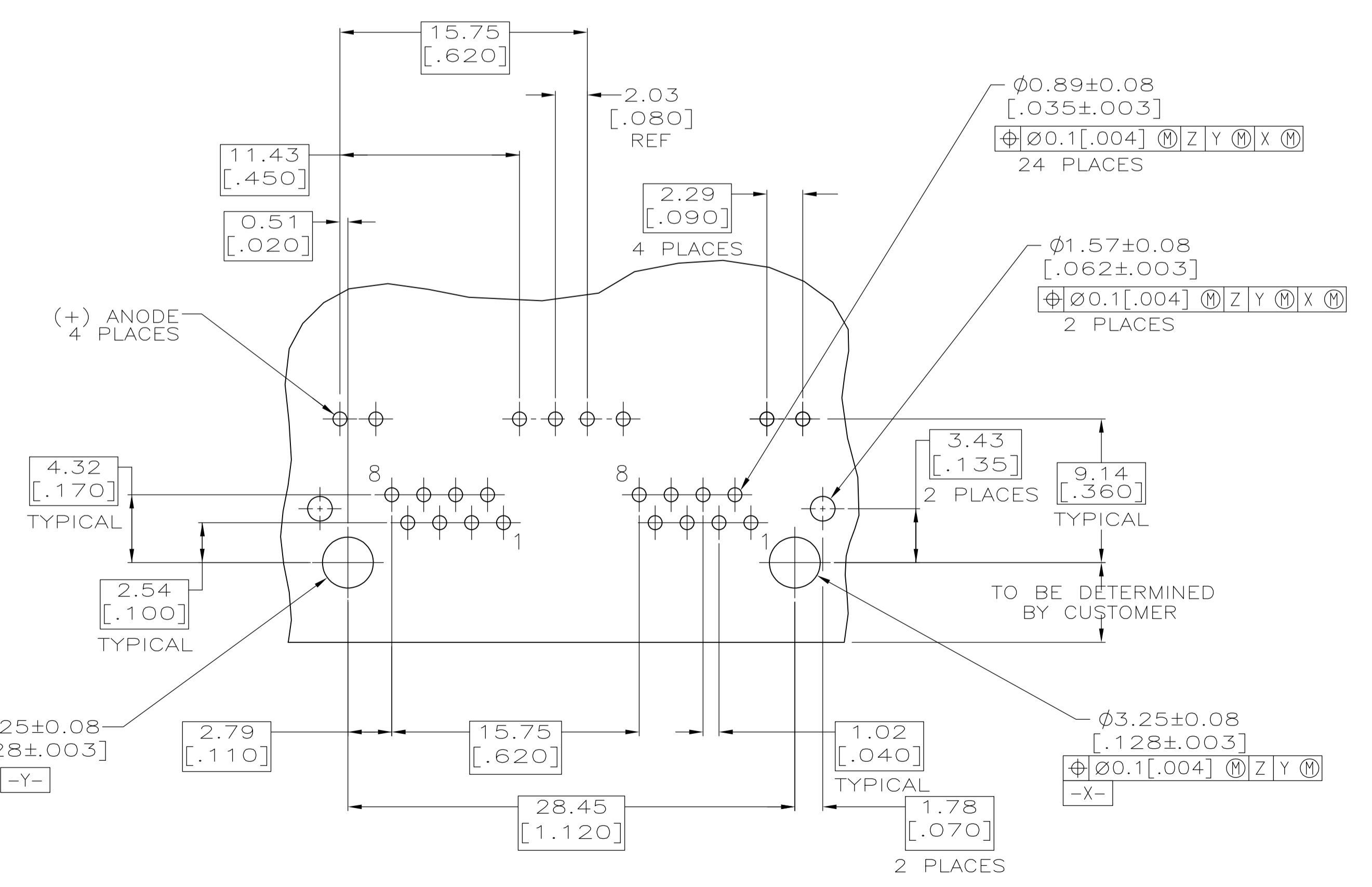
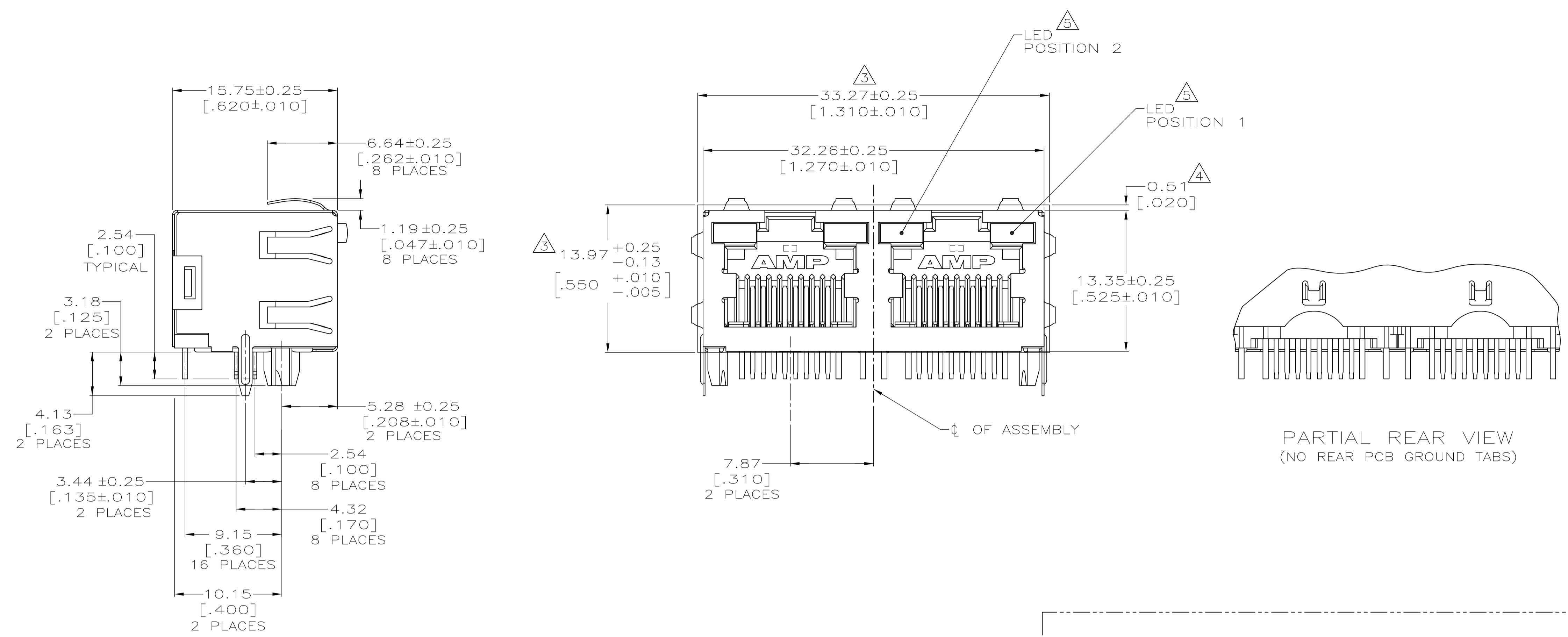


LOC	DIST	REVISIONS							
AA	22	REV	PER	EC	OS11-0201-04	DATE	DWN	APVD	
		A	REV	PER	EC	OS11-0201-04	15JUN2005	LV	SF
		A1	REVISED	PER	ECO-10-000444		19JAN10	KK	HMR

- MATERIAL:**
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81 μ m[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27 μ m [0.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27 μ m [0.000050] MINIMUM THICK NICKEL.
 SHIELD - 0.196[.0077] THICK COPPER ZINC ALLOY PREPLATED WITH 1.27 μ m[.000050] MINIMUM SATIN NICKEL WITH 2.03 μ m[.000080] MINIMUM TIN POST DIPPED ON PCB GROUND TABS.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89 μ m[.0003500] THICK Sn/Cu OVER 2.03 μ m[.000080] THICK Ag OVER 1.02 μ m[.000040] THICK Cu OVER 3.56 μ m[.000140] THICK Ni OVER 1.02 μ m[.000040] Cu UNDERPLATE
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
 - Δ SUGGESTED PANEL OPENING DIMENSIONS.
 - Δ SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.
 - Δ SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
 - THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.
 - Δ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
 (COMPONENT SIDE)

INDICATOR COLOR FOR EACH HOUSING	POSITION 2	POSITION 1	PART NUMBER
Δ OBSOLETE	RED/GREEN	GREEN/YELLOW	-2-6368214-2-
	GREEN/YELLOW	GREEN/YELLOW	6368214-8
	POSITION 2	POSITION 1	

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN L. VARELA - DOCKS 15JUN2005 CHK J. WESTMAN 15JUN2005 APVD S. FLICKINGER 15JUN2005 NAME PRODUCT SPEC 108-1163-4 APPLICATION SPEC 114-2154 WEIGHT - CUSTOMER DRAWING	
DIMENSIONS: mm[inches] TOLERANCES UNLESS OTHERWISE SPECIFIED: 0. PLC ± - 1. PLC ± - 2. PLC ± 0.25[.01] 3. PLC ± 0.13[.005] 4. PLC ANGLES ± - MATERIAL Δ FINISH Δ		Tyco Electronics Corporation Harrisburg, PA 17105-3608 INVERTED MODULAR JACK ASSEMBLY, 1X2, SHIELDED, PANEL GROUND, NO REAR PCB GROUND TABS, WITH LEDS SIZE CAGE CODE DRAWING NO A1 00779 C=6368214 SCALE 4:1 SHEET 1 OF 1 REV A1	